

FABRICATION AND PROPERTIES OF NANOCRYSTALLINE DIAMOND FILMS

Dr. Stoffel D. Janssens and Prof. Dr. K. Haenen



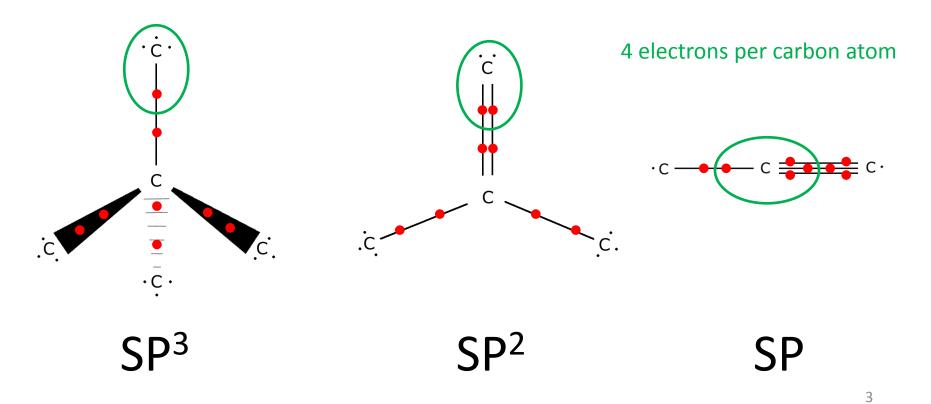
Outline

- <u>Diamond</u>
- Diamond growth
- Intrinsic NCD layers
- Boron-doped NCD



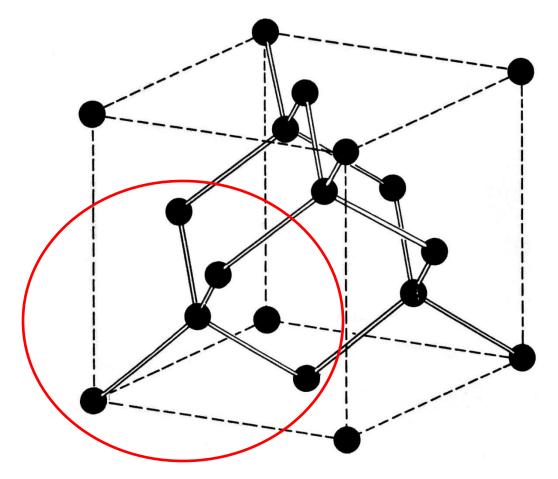
Diamond

- Carbon atoms
 - \rightarrow 4X attached to each other





Diamond



• Carbon \rightarrow 4 bonds

- Crystal
- Cubic crystal lattice

Introduction to Solid State Physics (C. Kittel)



Diamond: properties

Chemical

- Resistant to chemical corrosion (survives strong acidic treatments)
- Biologically compatible (no rejection by human body)
- Radiation hard (survives heavy radiation)
- High electrochemical window



Diamond: properties

Optical / Thermal

- Broad optical transparency from UV to IR (Sun tanning behind a diamond window)
- High thermal conductivity (Fast heat energy transport)
- Low thermal expansion coefficient (Not shrinking much, when cooling down)



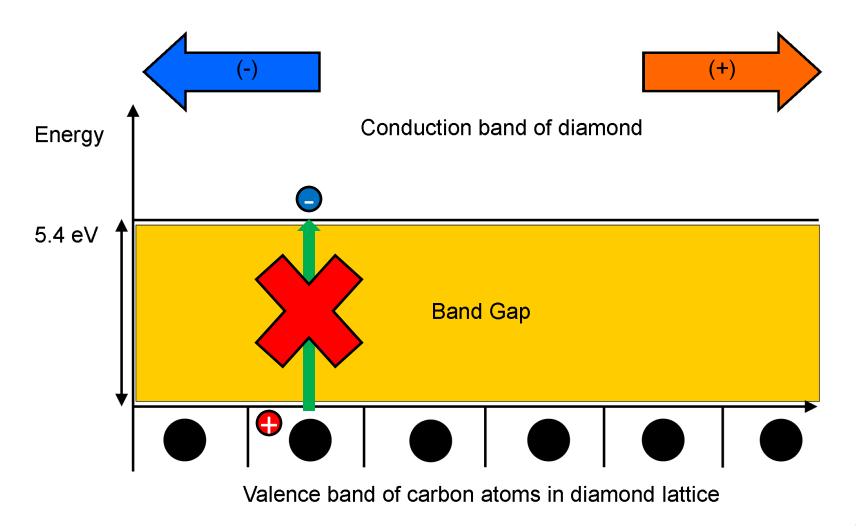
Diamond: properties

Electronic / Mechanical

• <u>High electrical resistivity</u> (*Difficult to create charge carriers*)



High electrical resistivity





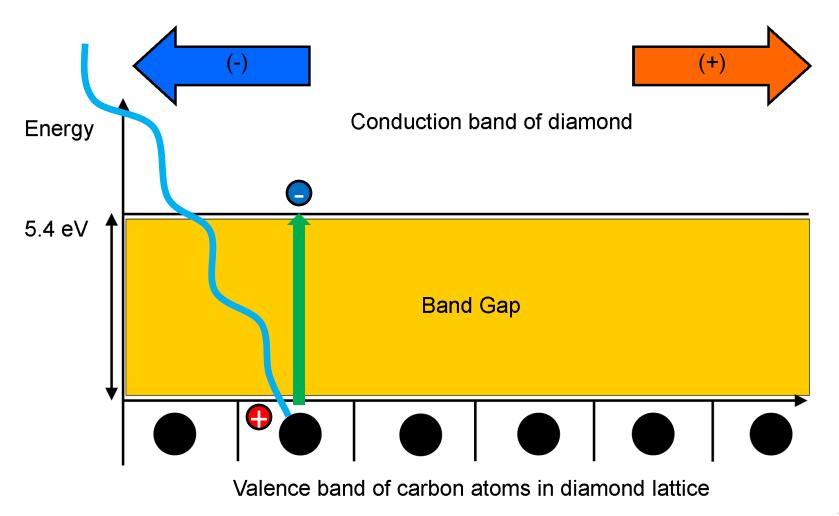
Diamond: properties

Electronic / Mechanical

- High electrical resistivity (Difficult create charge carriers)
- <u>High electrical mobility</u> (Once charge carriers are created, they are easily transported)

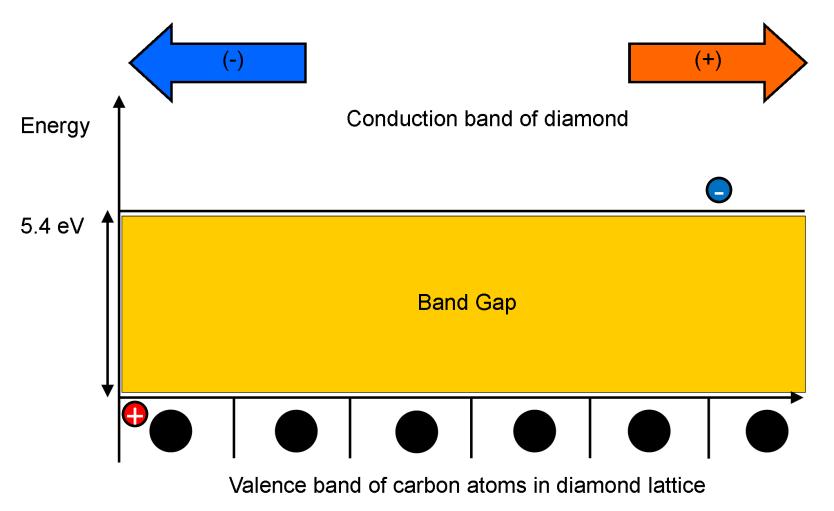


High electrical mobility





High electrical mobility





Diamond: properties

Electronic / Mechanical

- High electrical resistivity (Difficult create charge carriers)
- High electrical mobility (Once charge carriers created, they are easily transported)
- <u>Hardest material</u> (It scratches everything)



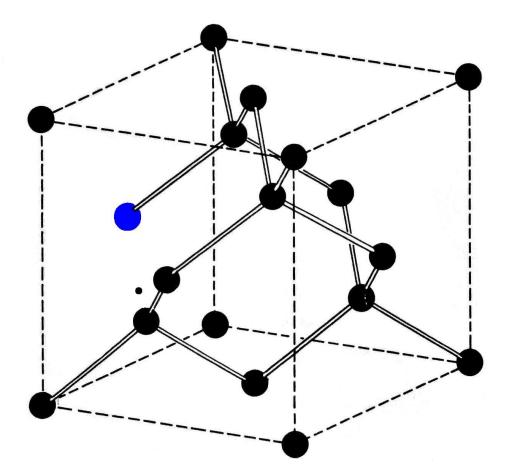
Diamond: doped

	Boron:						s e₋									-	
la	Carbon:						Ζ	l e⁻									0
1 H												Illa	IVa	Va	Vla	VIIa	2 He
3	4	Nitrogen:					5 e⁻					5	6	7	8	9	10
Li	Be	Phosphorus: 5 e ⁻											C	N	0	F	Ne
11	12												14	15	16	17	18
Na	Mg	IIIb	IVb	Vb	Vlb	VIIb	VIIIb	VIIIb	VIIIb	lb	llb	AI	Si	Р	s	СІ	Ar
19	20	21	22	23	24	25	26	27	28	29	30	31	32	33	34	35	36
K	Са	Sc	Ti	V	Cr	Mn	Fe	Co	Ni	Cu	Zn	Ga	Ge	As	Se	Br	Kr
37	38	39	40	41	42	(43)	44	45	46	47	48	49	50	51	52	53	54
Rb	Sr	Y	Zr	Nb	Мо	Тс	Ru	Rh	Pd	Ag	Cd	In	Sn	Sb	Те	- I	Хе
55	56		72	73	74	75	76	77	78	79	80	81	82	83	84	85	86
Cs	Ba	*	Hf	Та	W	Re	Os	lr	Pt	Au	Hg	TI	Pb	Bi	Ро	At	Rn
87	88		(104)	(105)	(106)	(107)	(108)	(109)	(110)	(111)	(112)	(113)	(114)	(115)	(116)	(117)	(118)
Fr	Ra	**	Rf	Db	Sg	Bh	Hs	Mt	Ds	Rg	Cn	Uut	Uuq	Uup	Uuh	Uus	Uuo
		57	58	59	60	(61)	62	63	64	65	66	67	68	69	70	71	
		La	Се	Pr	Nd	Pm	Sm	Eu	Gd	Tb	Dy	Но	Er	Tm	Yb	Lu	
		89	90	91	92	(93)	(94)	(95)	(96)	(97)	(98)	(99)	(100)	(101)	(102)	(103)	
		Ac	Th	Pa	U	Np	Pu	Am	Cm	Bk	Cf	Es	Fm	Md	No	Lr	

13



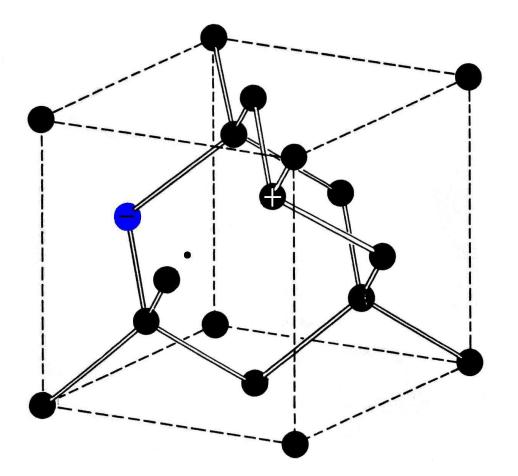
Diamond: doped (Boron)



- Boron-doped diamond
- B binds 1 time less
- One bond \rightarrow 2 electrons
- T = 0 K



Diamond: doped (Boron)

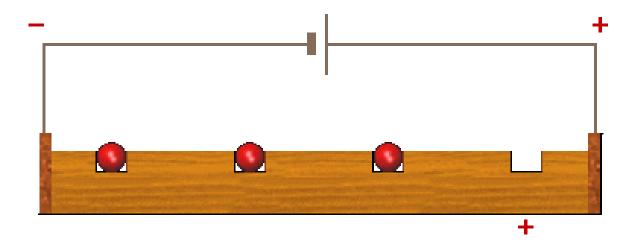


- T = 0 K \rightarrow T > 0 K
- Hole floats around
- P-type semiconductor (holes are Positive and float around)



Diamond: doped (Boron)

• Hole conduction!!!



© 2006 www.radartutorial.de

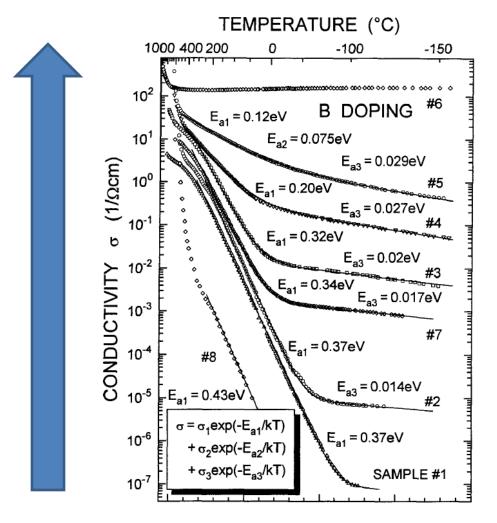


Diamond: doped (Boron)

- What are the effects of boron incorporation?
- Improvement of some properties
 <u>-(Higher conductivity)</u>



Higher conductivity



Borst et al., Diamond Relat. Mater. 4, 948 (1995).

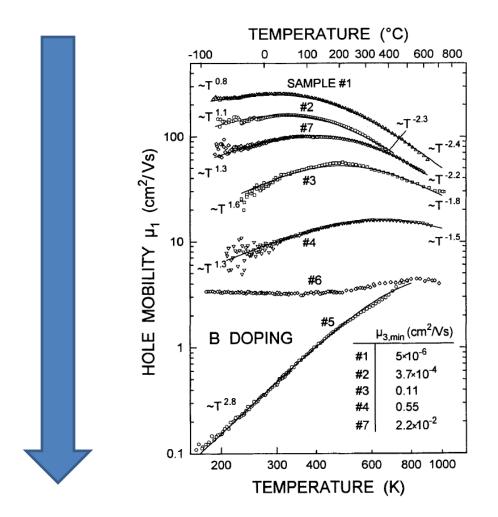


Diamond: doped (Boron)

- What are the effects of boron incorporation?



Lower hole mobility



Borst et al., Diamond Relat. Mater. 4, 948 (1995).



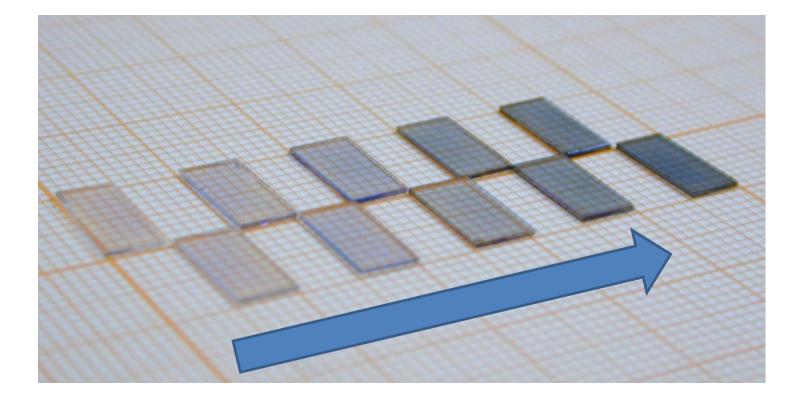
Diamond: doped (Boron)

- What are the effects of boron incorporation?

-(Lower optical transparency)



Lower optical transparency





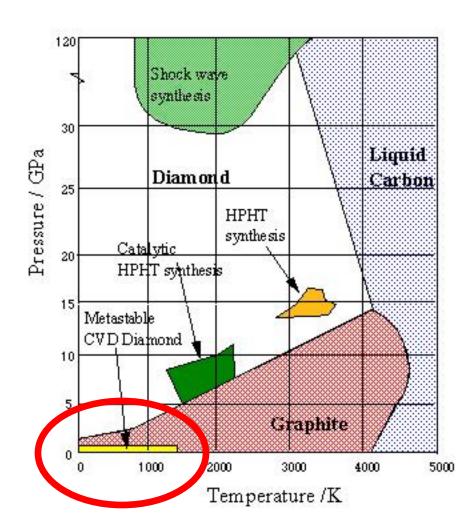
Outline

- Diamond
- Diamond growth
- Intrinsic NCD layers
- Boron-doped NCD



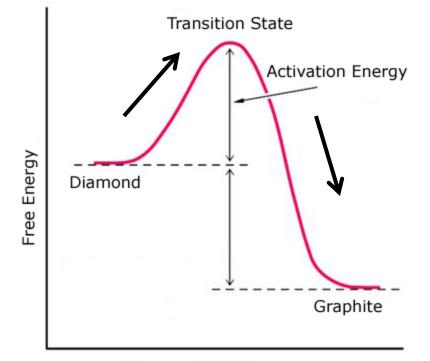
Diamond growth

• <u>Bundy et al.</u> <u>Phase diagram</u> <u>of carbon</u>





Diamond growth: Energy diagram

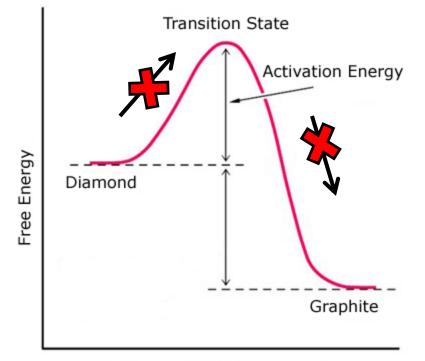


• Easily over barrier → Diamond unstable

Reaction coordinate



Diamond growth: Energy diagram



Reaction coordinate

- Easily over barrier
 → Diamond unstable
- Very difficult over barrier
 → Diamond metastable

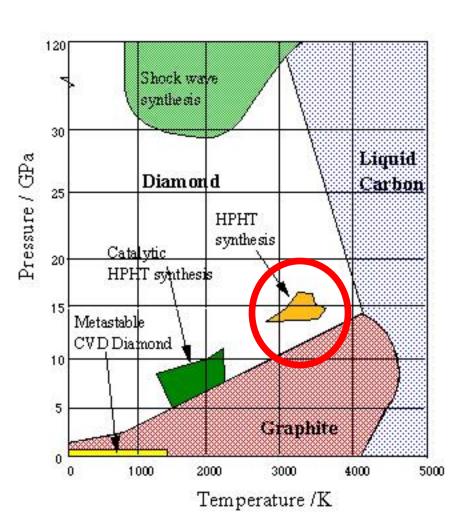
Last scenario at standard ambient conditions.



Diamond growth: HPHT (Nature)

- Bundy et al. Phase diagram of carbon
- <u>HPHT</u>

<u>-Nature's way</u> (till 4 cm diameter)





Diamond growth: HPHT (Nature)

Size:

Approximately 12.4 x 10.5 x 8.4 mm *Location:* natural diamond rough mined in Congo *Price:* \$547.20

This natural diamond crystal weighs 6.84 carats! It is translucent to semitransparent with a cubic shape. Its in very good condition overall, and it has greyishyellowish-green <u>natural</u> color.

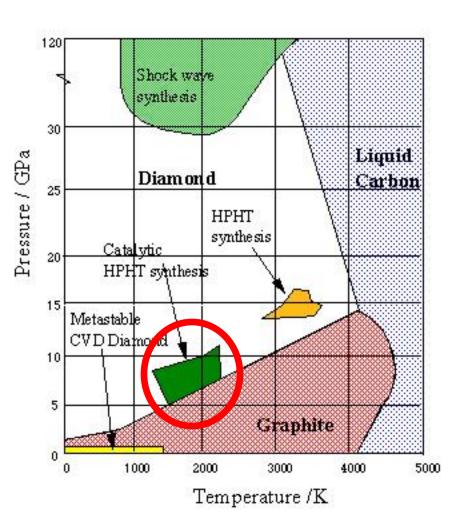




Diamond growth: HPHT (Synthetic)

- Bundy et al. Phase diagram of carbon
- HPHT

-Natures way (till 4 cm diameter) -<u>Synthetic (Catalytic)</u> (Large diamonds (mm))





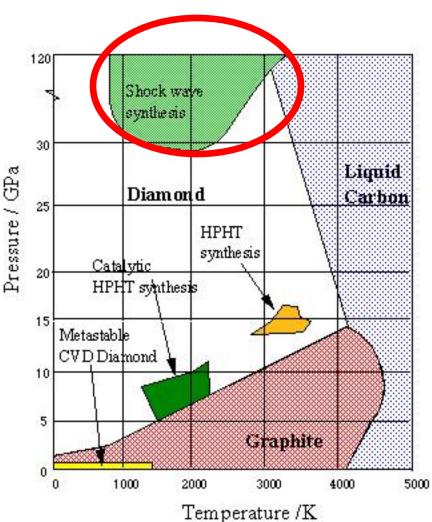
Diamond growth: HPHT (Synthetic)





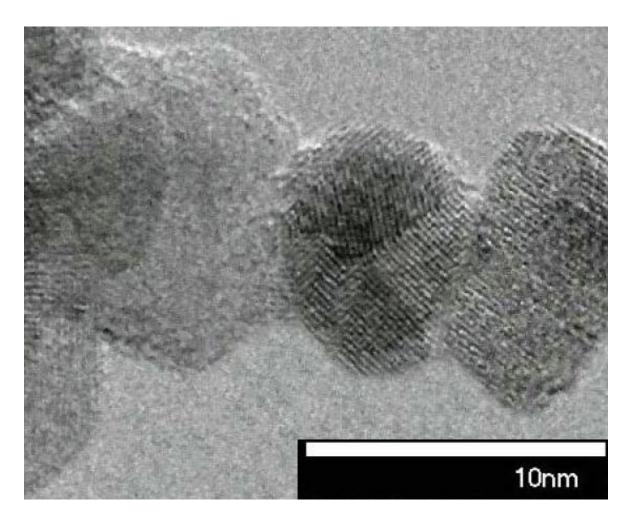
Diamond growth: Shock wave

- Bundy et al. Phase diagram of carbon
- <u>Shock wave:</u> <u>TNT in vessel</u> (5 to 10 nm diameter)





Diamond growth: Shock wave

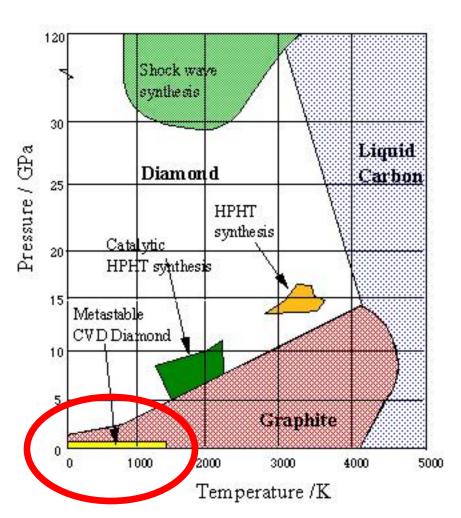


lakoubovskii et al., Nanotechnology 19, 155705 (2008)



Diamond growth: CVD

- Bundy et al. Phase diagram of carbon
- <u>Chemical vapor</u> <u>deposition (CVD)</u> <u>-Highly pure diamond</u>
 - <u>-P,N,B-doping</u> <u>-Thin or thick layers</u> <u>-Polycrystalline diamond</u>



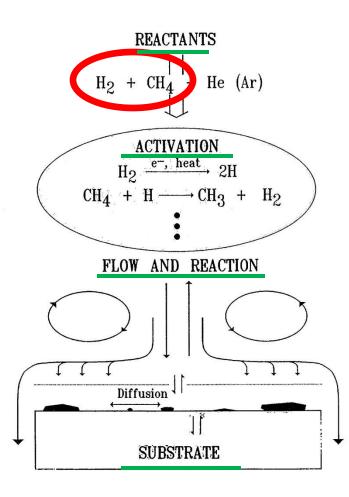


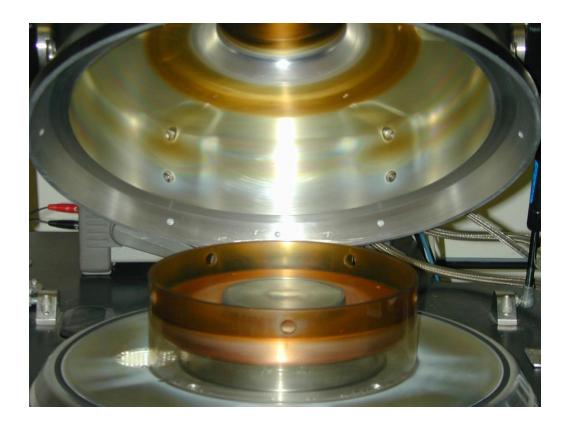
Diamond growth: CVD





Diamond growth: CVD





Carbon/Hydrogen-ratio (C/H-ratio): low
 Doping (TMB, PH₃, N₂)

Butler et al. Phil. Trans. R. Soc. A 342, 209 (1993)



Diamond growth: CVD (Substrates)

Single crystal diamond

Chemical Vapor Deposition

High Pressure High Temperature diamond OR Iridium

- Pure (intrinsic)
- Boron-doped
 - Phosphorus-doped
 - Nitrogen-doped

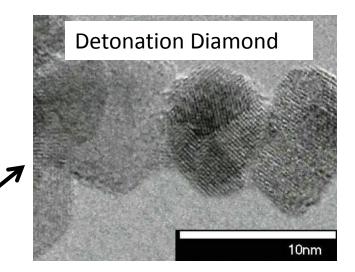


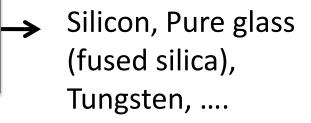
. . .



Diamond growth: CVD (Substrates)

Polycrystalline diamond Dipping of substrate in detonation diamond suspension



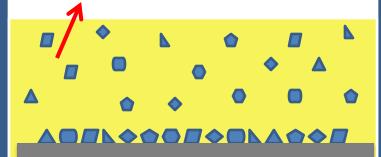




Diamond growth: CVD (Substrates)

Polycrystalline diamond

Suspension: Particles float around due to movement of liquid

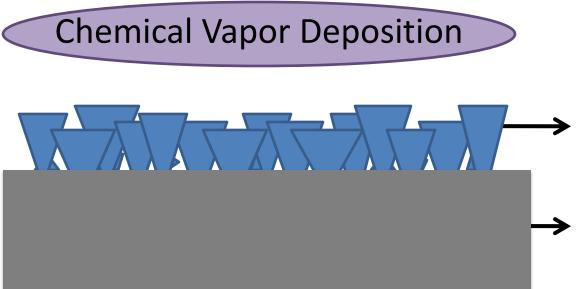






Diamond growth: CVD (growth)

Polycrystalline diamond: nanocrystalline diamond



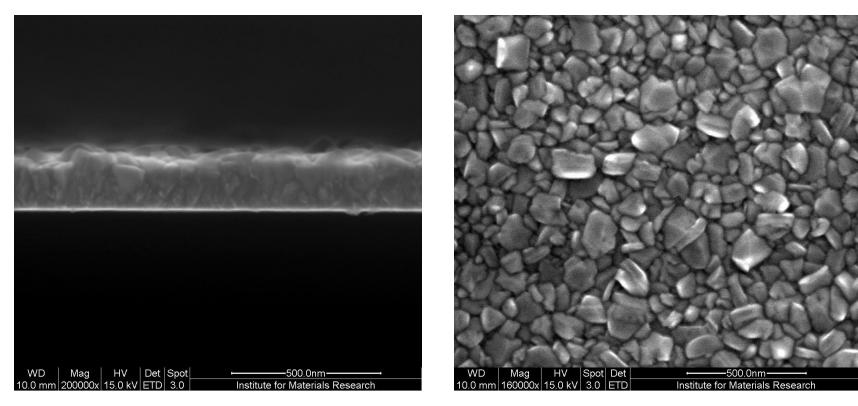
Nanocrystalline diamond film (NCD) (till 500 nm grains)

 Silicon, fused silica, Tungsten,



Diamond growth: Characterization

Scanning electron microscopy: nanocrystalline diamond

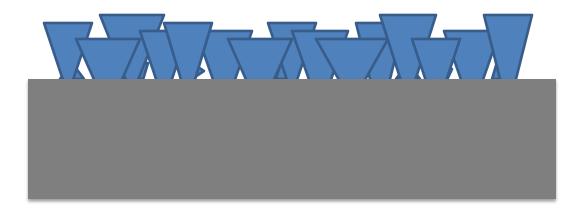




Diamond growth: CVD (growth)

Polycrystalline diamond: *microcrystalline diamond*

Chemical Vapor Deposition





Diamond growth: CVD (growth)

Polycrystalline diamond: *microcrystalline diamond*

Microcrystalline diamond (from 500 nm grains)



Outline

- Diamond
- Diamond growth
- Intrinsic NCD layers
- Boron-doped NCD



Intrinsic NCD layers

Undoped nanocrystalline diamond layers

Higher quality obtained by:

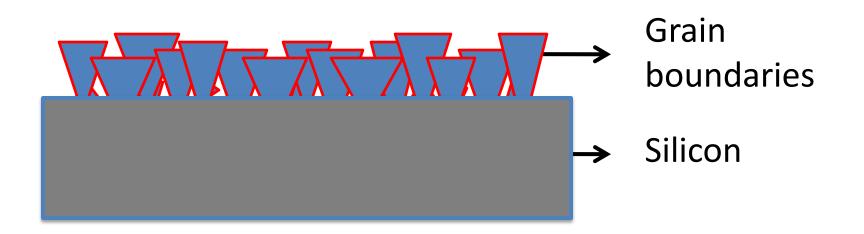
- 1. Increasing film thickness AND/OR
- 2. Decreasing C/H-ratio

Larger grains \rightarrow less grain boundaries



Intrinsic NCD layers

Nanocrystalline diamond layers





Intrinsic NCD layers

Nanocrystalline diamond layer

Higher quality obtained by:

1. Increasing film thickness → Fixed Thickness AND/OR

2. Decreasing C/H-ratio → Change C/H-ratio
 Larger grains → less grain boundaries
 Higher diamond quality



Intrinsic NCD layers

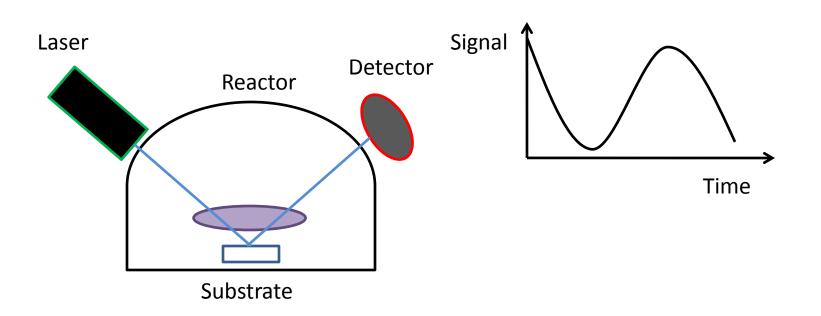
Growth Conditions

- Temperature: 775 °C
- Microwave Power: 3500 Watt
- Pressure: 27 hPa (20 torr)
- Thickness: 150 nm
- C/H-ratio: 0.5%, 1%, 2%, 4%, 8%



Intrinsic NCD layers

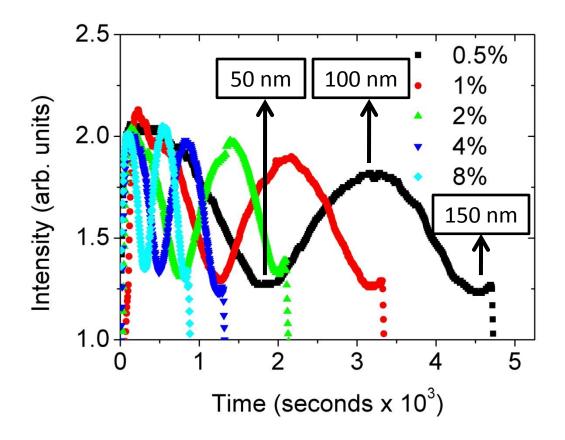
Thickness: Laser interference during growth





Intrinsic NCD layers

Thickness: Laser interference during growth

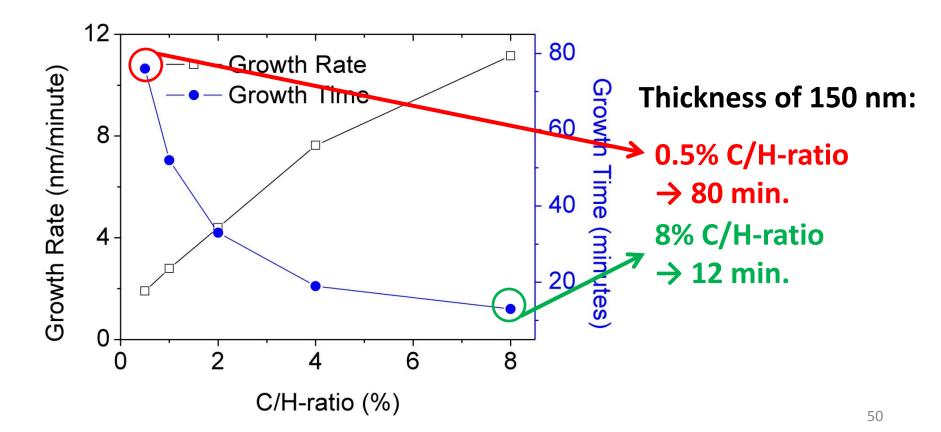


Interference: Every 50 nm 3 X 50 nm = 150 nm



Intrinsic NCD layers

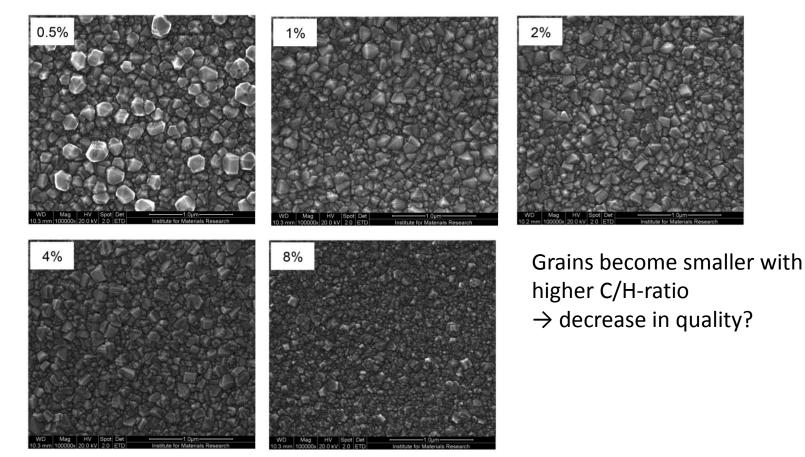
Growth Time





Intrinsic NCD layers

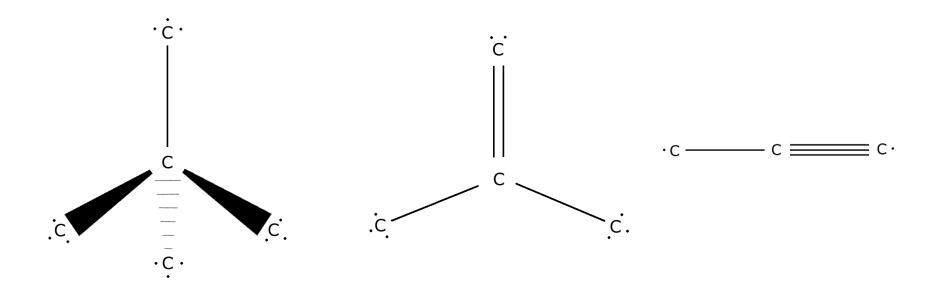
Scanning Electron Microscopy





Intrinsic NCD layers

Raman spectroscopy

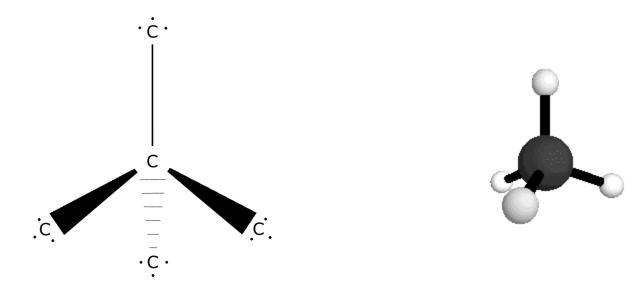


Sensitive for vibrations of carbon atom bonds



Intrinsic NCD diamond layers

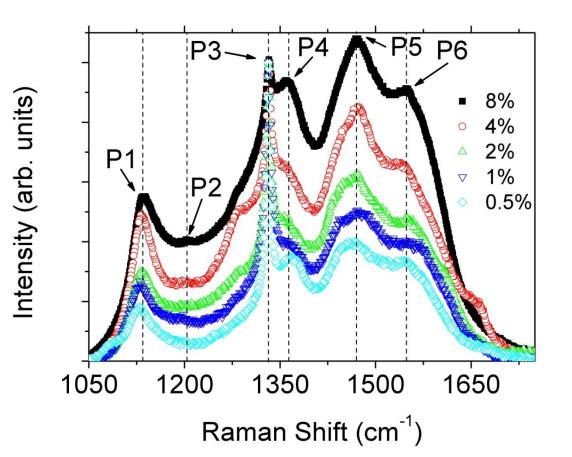
Raman spectroscopy





Intrinsic NCD layers

Raman spectroscopy



P3 = diamond peak Rest = non-diamond peaks

Increase of diamond peak and decrease in other peaks when decreasing the methane concentration from 8% to 0.5%



Intrinsic NCD diamond layers

Conclusion

Growth with lower C/H-ratio

- 1. Longer growth time
- 2. Larger grains
- 3. Higher diamond quality



Outline

- Diamond
- Diamond growth
- Intrinsic NCD layers
- Boron-doped NCD



Boron-doped NCD

Heavily boron-doped NCD

Growth with lower C/H-ratio

- 1. Longer growth time
- 2. Larger grains
- 3. Higher diamond quality
- 4. Boron incorporation?
- 5. Electronic properties?

Intrinsic diamond

Janssens et al., New J. Phys. **13**, 083008 (2011)



Boron-doped NCD

Diamond vs. Silicon

Single crystals

Electronic transport models similar Same amount of Valence Electrons Same Crystal Lattice

Polycrystalline

Influence of grain boundaries on Electromagnetic Transport Properties?

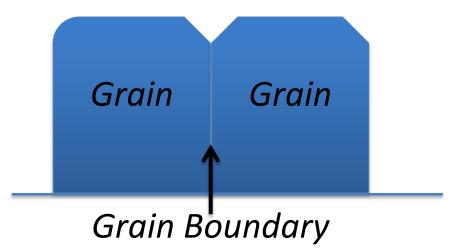


Doped polycrystalline silicon

Morphology vs. electromagnetic transport:

- Lu N C, et al. 1981 IEEE Trans. Electron Devices 28 818

$$\rho = \rho_{GB} \left(\frac{2w}{d} \right) + \rho_{SC} \left(1 - \frac{2w}{d} \right)$$





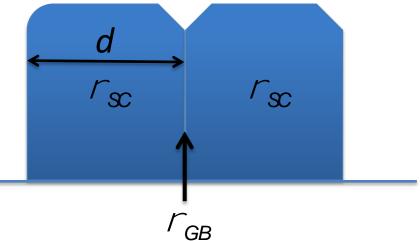
Doped polycrystalline silicon

Morphology vs. electromagnetic transport:

- Lu N C, et al. 1981 IEEE Trans. Electron Devices 28 818

$$\rho = \rho_{GB} \left(\frac{2w}{d} \right) + \rho_{SC} \left(1 - \frac{2w}{d} \right)$$

 $2w \approx$ width GB for metallic doping





Doped polycrystalline silicon

Morphology vs. electromagnetic transport:

- Lu N C, et al. 1981 IEEE Trans. Electron Devices 28 818

$$\rho = \rho_{GB} \left(\frac{2w}{d} \right) + \rho_{SC} \left(1 - \frac{2w}{d} \right) \qquad \frac{1}{\mu} = \frac{1}{\mu_{GB}} \left(\frac{2w}{d} \right) + \frac{1}{\mu_{SC}} \left(1 - \frac{2w}{d} \right)$$

Set of samples

d (variable) → varying C/H-ratio ρ_{sc} and μ_{sc} (constant) → high B-concentration *2w* approx. constant → high B-concentration



Heavily-doped B:NCD

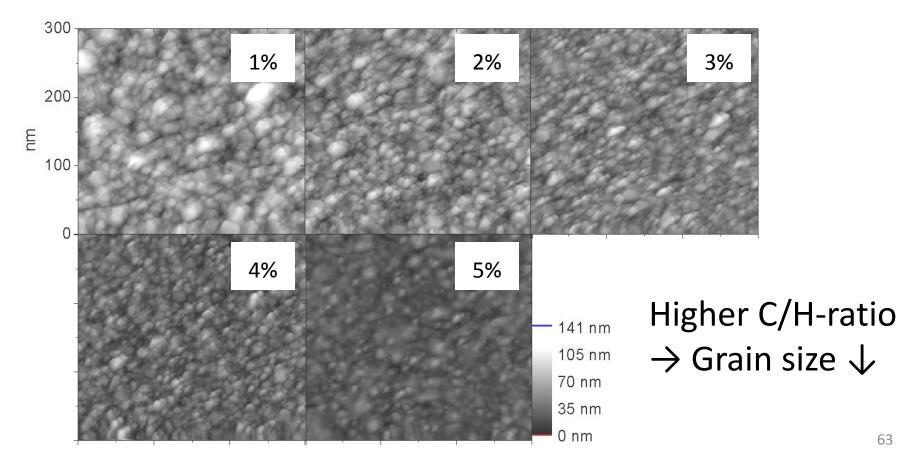
Growth Conditions

- Temperature: 700 °C
- Microwave Power: 3500 Watt
- Pressure: 33.3 hPa (25 torr)
- Thickness: 150 nm
- C/H-ratio: 0.5%, 1%, 1.5%, 2%, 2.5%, 3%, 3.5%
 4%, 4.5%, 5%
- B/C-ratio: 5000 ppm



Heavily-doped B:NCD

Morphology: Atomic force microscopy

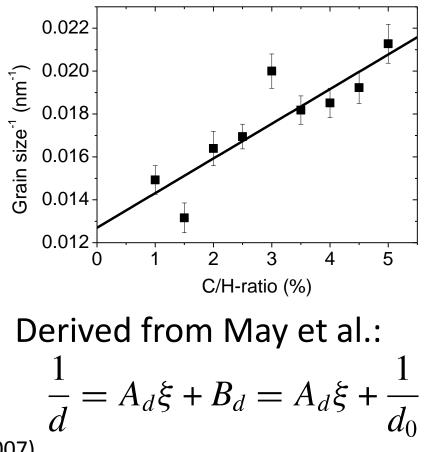




Heavily-doped B:NCD

Morphology: X-ray diffraction (*Scherrer equation*)

C/H-ratio (%)	Grain size (nm)
1	67
1.5	76
2	61
2.5	59
3	50
3.5	55
4	54
4.5	52
5	47



May et al., J. Appl. Phys. 101, 053115 (2007)



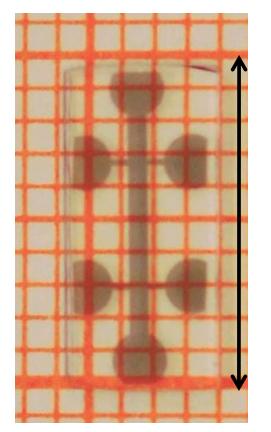
Heavily-doped B:NCD

Processing of samples: electronic measurements

- Hall bar shapes:
 - Protective Al mask (lift off photolithography)
 - Oxygen plasma etch (3 min, 300 W, 5.6 x 10-3 mbar)

• Contacts:

- Magnetron sputtered Ti/Al (50 nm/200 nm)

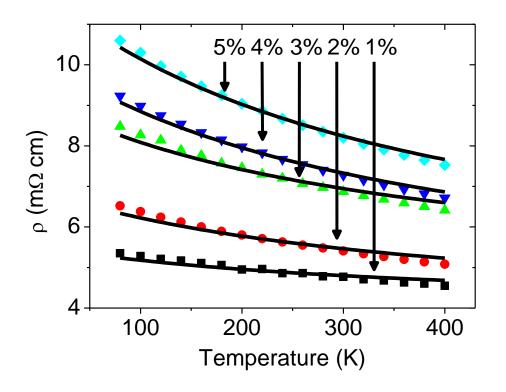


1 cm



Heavily B:NCD

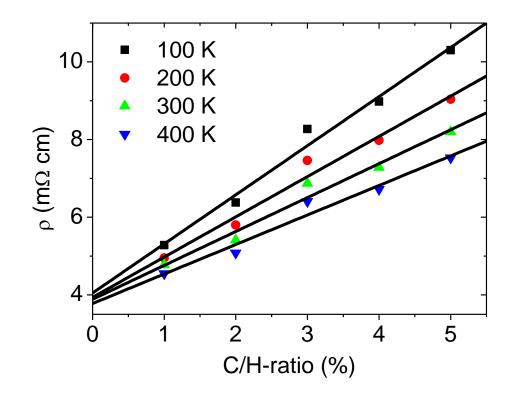
Electronic properties: resistivity = $\rho \div 1/(n \mu)$



- Resistivity:
 5% > ... > 1%
- T-dependence:
 5% > ... > 1%
- 3. Intuitive explanation: grain boundaries induce a higher resistivity



Electronic properties: resistivity



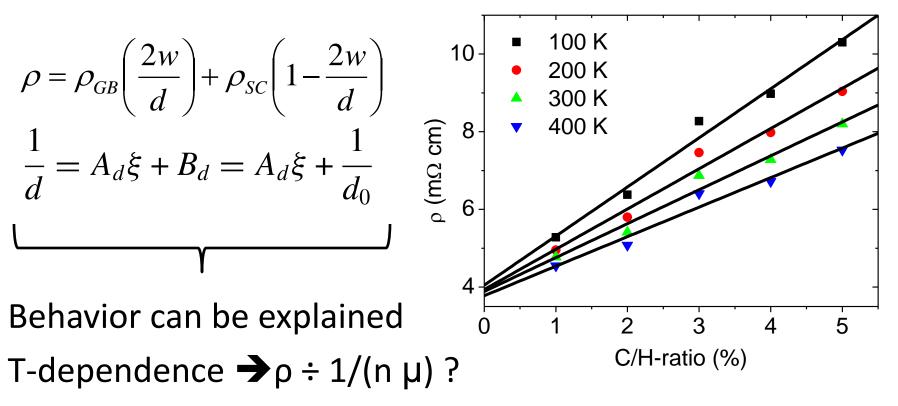
1. Plot:

ρ as a function of C/Hratio for all temperatures

2. Approximation: Linear dependence for all temperatures

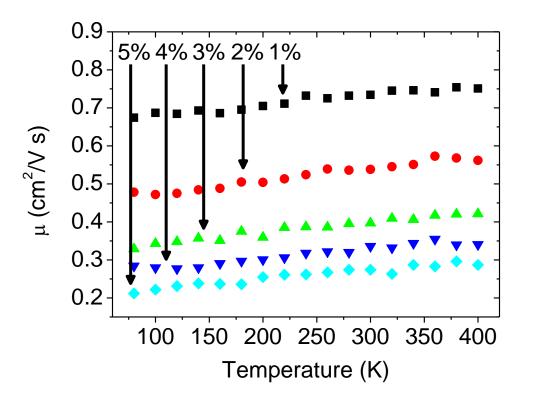


Electronic properties: resistivity





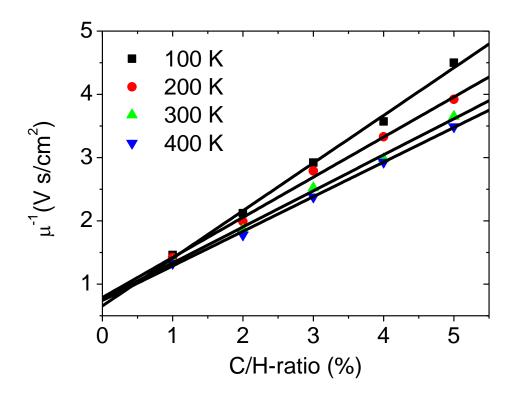
Electronic properties: mobility



- 1. Mobility (μ):
 - 1% > ... > 5%
- 2. T dependence: μ increases with T
- 3. Intuitive explanation: grain boundaries scatter



Electronic properties: mobility

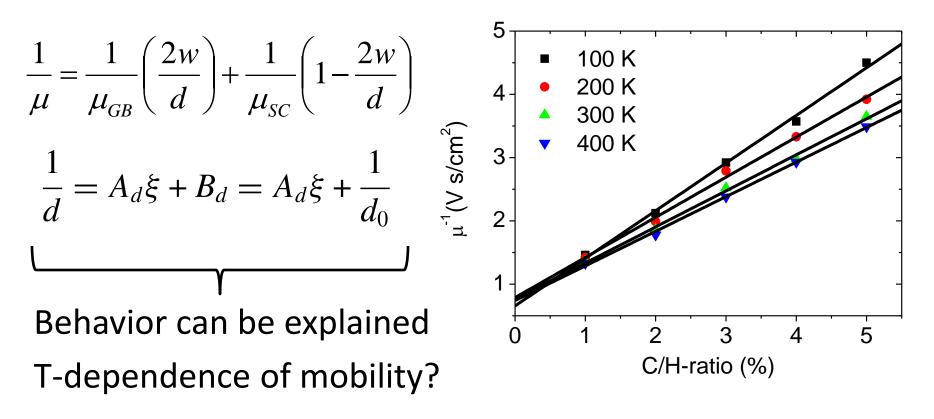


1. Plot: μ^{-1} as a function of C/Hratio for all temperatures

2. Approximation: Linear dependence for all temperatures



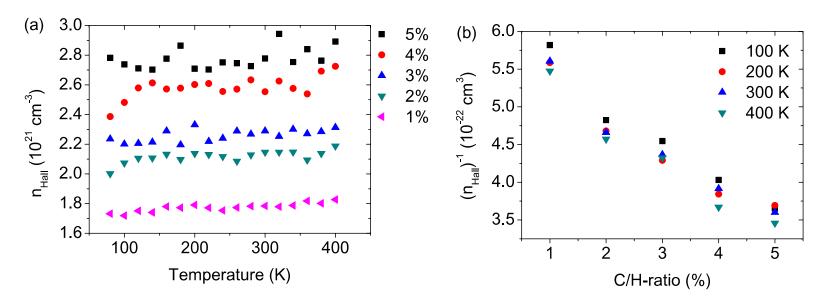
Electronic properties: mobility





Heavily B:NCD

Electronic properties: charge carrier density

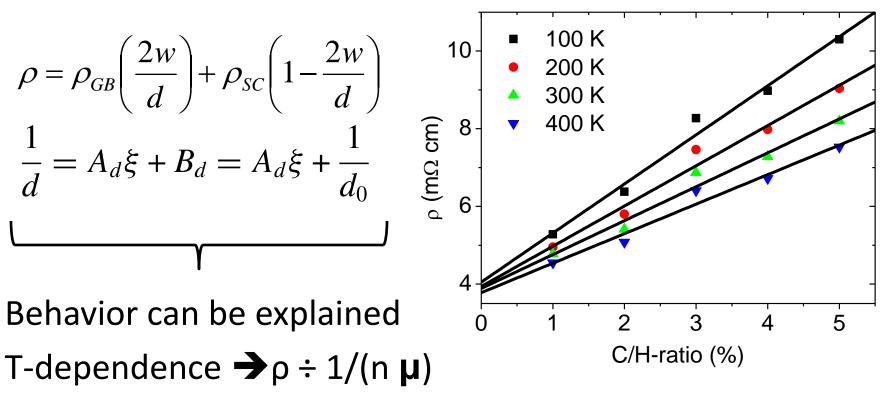


Behavior can be explained by more B-incorporation as a function of C/H ratio.

No observed T-dependence for C/H-ratio



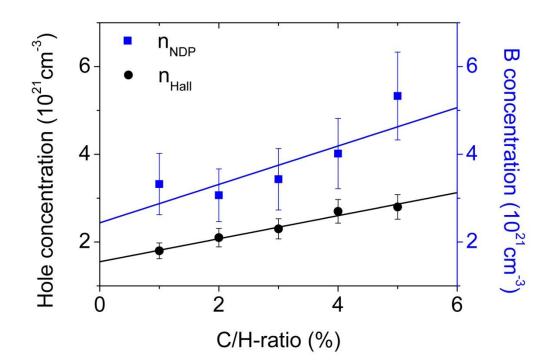
Electronic properties: resistivity





Active and total boron concentration:

- Active [B] from Hall effect measurements (n_{Hall})
- Total [B] from neutron depth profiling (n_{NDP})



With increasing C/H-ratio

- 1. Increase in boron incorporation
- 2. More and more inactive boron incorporation

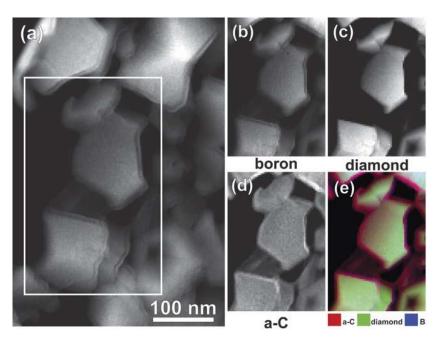
50-70% active incorporated (@ 400K)



Heavily B:NCD

Active and total boron concentration:

Nanoscopic investigation with TEM and EELS



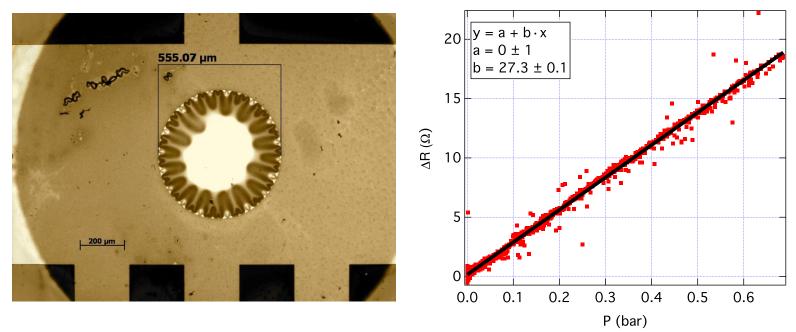
S. Turner et al. Nanoscale, 2012, 4, 5960

No preferential B-incorporation



Piezoresistive properties

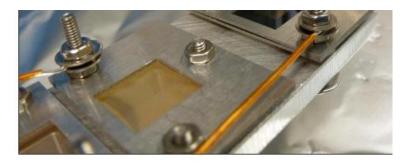
• 150 nm thick B-NCD membrane on glass, in the middle of a Hall bar structure (to be published).





Heavily B:NCD

Soft X-ray detectors

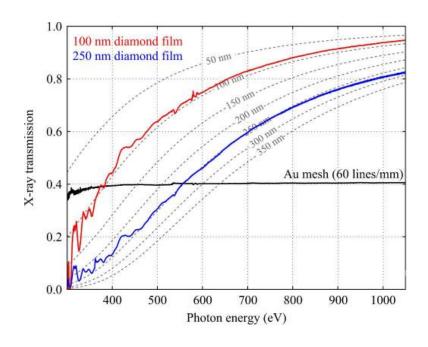


10ton flux monitor

focussing mirrors

100 and 250 nm thick diamond membranes on silicon (0.5 mm by 0.5 mm)







Acknowledgements

- Belgian Science Policy (BELSPO), Belgium
 - Interuniversity Attraction Poles Project P6/42
- Research Foundation Flanders (FWO), Belgium
 - Research projects G.0068.07N, G.0555.10N &
 G.0430.07N Leuven, Hasselt
 - Methusalem "NANO" network Antwerpen–Hasselt
- Matcon Molesol project